

Glass Passivated Single-Phase Bridge Rectifier, 35A

GBPC3506 Thru GBPC3516

FEATURES

- UL recognition file number E320098
- Universal 3-way terminals: snap-on, wire wrap-around, or PCB mounting
- Typical IR less than 1.0 μ A
- High surge current capability
- Low thermal resistance
- Solder dip 260°C, 40s
- Compliant to RoHS
- Glass passivated chips

TYPICAL APPLICATIONS

General purpose use in AC/DC bridge full wave rectification for power supply, home appliances, office equipment, industrial automation applications.

MECHANICAL DATA

Case: GBPC, GBPC-W

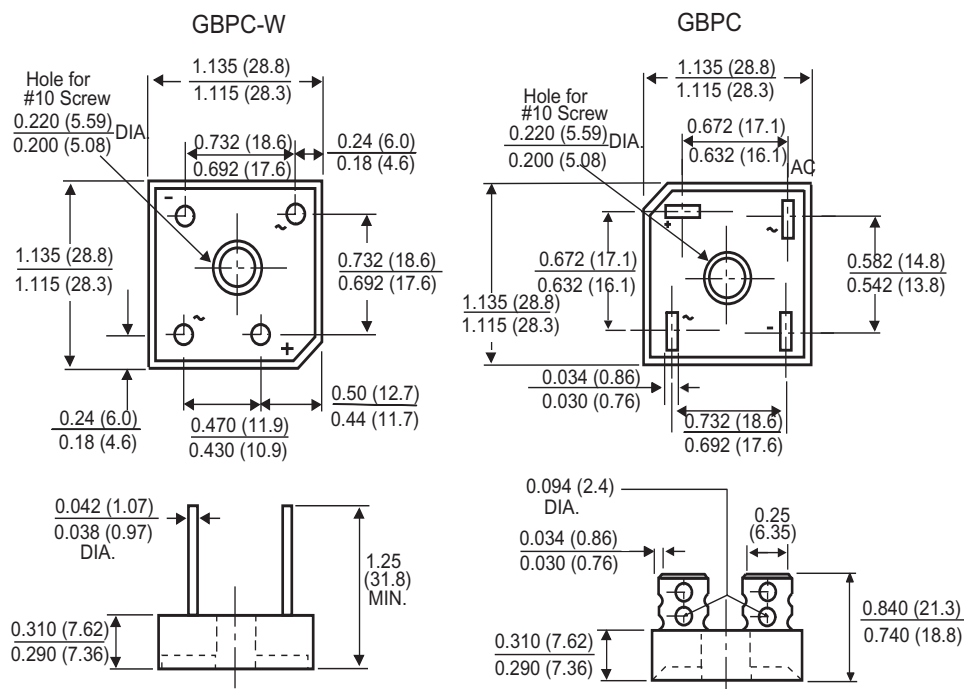
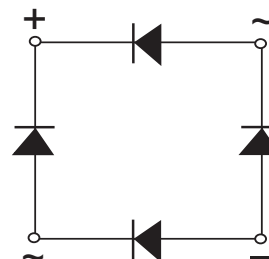
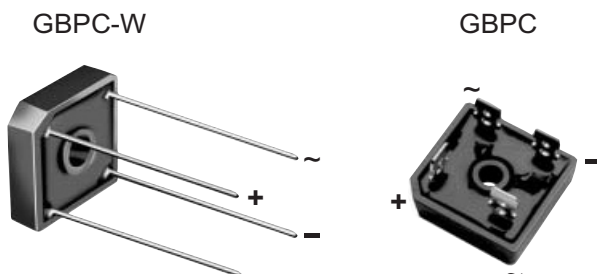
Epoxy meets UL 94 V-O flammability rating

Terminals: Nickel plated on faston lugs or silver plated on wire leads, solderable per J-STD-002 and JESD22-B102. Suffix letter "W" added to indicate wire leads(e.g. GBPC3506W).

Polarity: As marked, positive lead by beveled corner

Mounting Torque: 20 inches-lbs. max. (M5 screw)

Weight: 14g (0.49 ozs)



PRIMARY CHARACTERISTICS

$I_{F(AV)}$	35A
V_{RRM}	600V to 1600V
I_{FSM}	400A
I_R	5 μ A
V_F	1.1V
$T_{Jmax.}$	150°C

MAXIMUM RATINGS ($T_A = 25^\circ\text{C}$ unless otherwise noted)

PARAMETER	SYMBOL	GBPC35					UNIT
		06	08	10	12	16	
Maximum repetitive peak reverse voltage	V_{RRM}	600	800	1000	1200	1600	V
Maximum RMS voltage	V_{RMS}	420	560	700	840	1120	V
Maximum DC blocking voltage	V_{DC}	600	800	1000	1200	1600	V
Maximum average forward rectified output current (Fig.1)	$I_{F(AV)}$	35					A
Peak forward surge current single sine-wave superimposed on rated load	I_{FSM}	400					A
Rating (non-repetitive, for t greater than 1 ms and less than 8.3 ms) for fusing	I^2t	660					A ² s
RMS isolation voltage from case to leads	V_{ISO}	2500					V
Operating junction storage temperature range	T_J, T_{STG}	-55 to 150					°C

ELECTRICAL CHARACTERISTICS ($T_A = 25^\circ\text{C}$ unless otherwise noted)

PARAMETER	TEST CONDITIONS	SYMBOL	GBPC35					UNIT
			06	08	10	12	16	
Maximum instantaneous forward drop per diode	I _F = 17.5A	V _F	1.1					V
Maximum reverse DC current at rated DC blocking voltage per diode	T _A = 25°C	I _R	5					µA
	T _A = 150°C		500					
Typical junction capacitance per diode	4V, 1MHz	C _J	300					pF

THERMAL CHARACTERISTICS ($T_A = 25^\circ\text{C}$ unless otherwise noted)

PARAMETER	SYMBOL	GBPC35					UNIT
		06	08	10	12	16	
Typical thermal resistance	$R_{\theta JC^{(1)}}$	1.4					°C/W

Notes

(1) With heatsink

(2) Bolt down on heatsink with silicone thermal compound between bridge and mounting surface for maximum heat transfer with M5 screw

Fig.1 Maximum Output Rectified Current

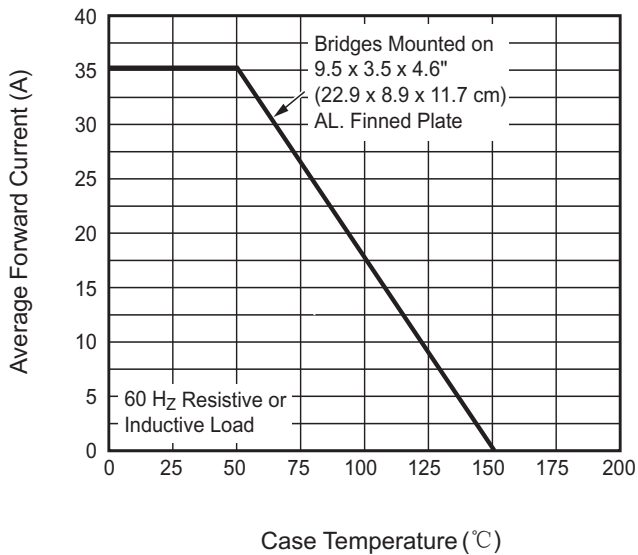


Fig.2 Maximum Output Rectified Current

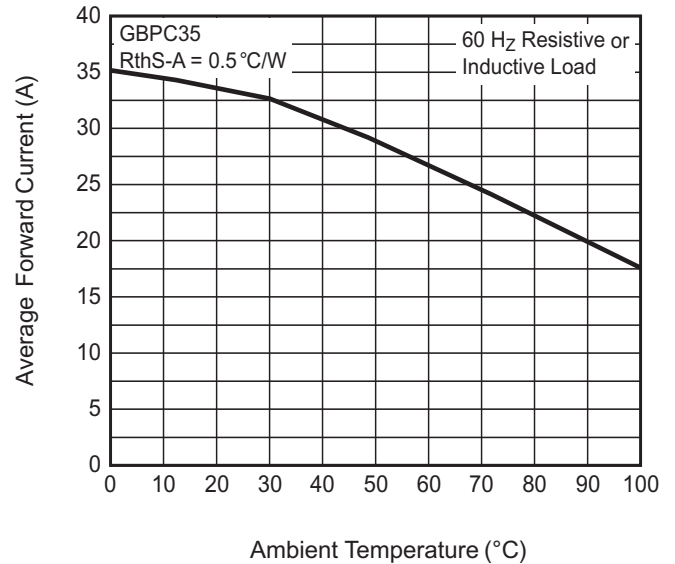


Fig.3 Maximum Power Dissipation

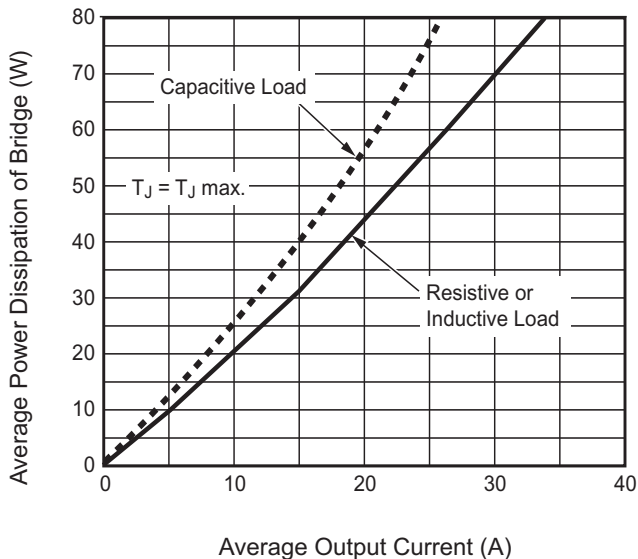


Fig.4 Maximum Non-Repetitive Peak Forward Surge Current Per Diode

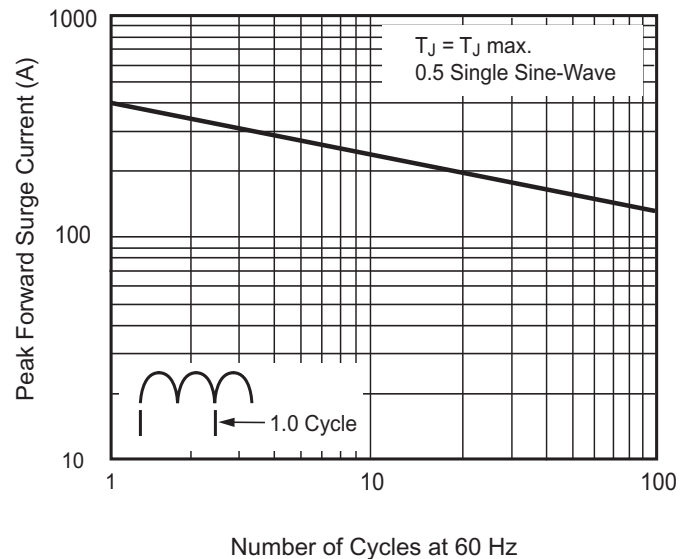


Fig.5 Typical Instantaneous Forward Characteristics Per Leg

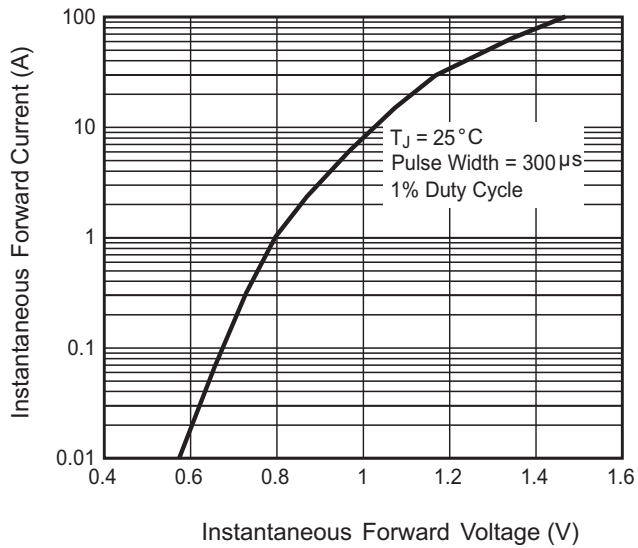


Fig.6 Typical Reverse Leakage Characteristics Per Leg

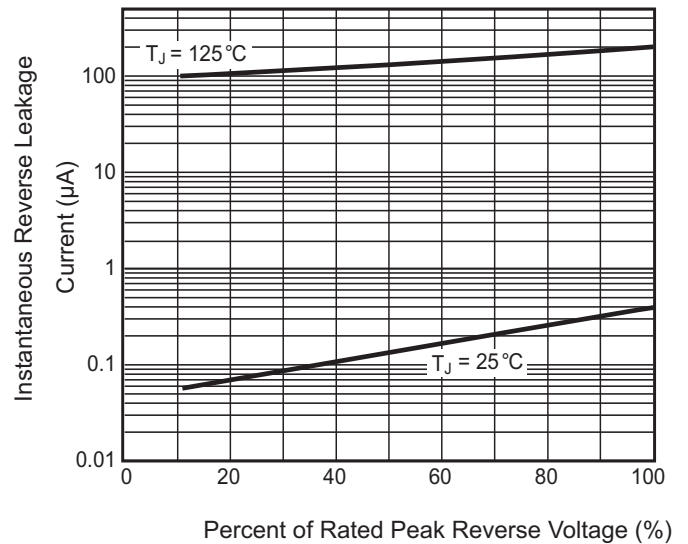


Fig.7 Typical Junction Capacitance Per Leg

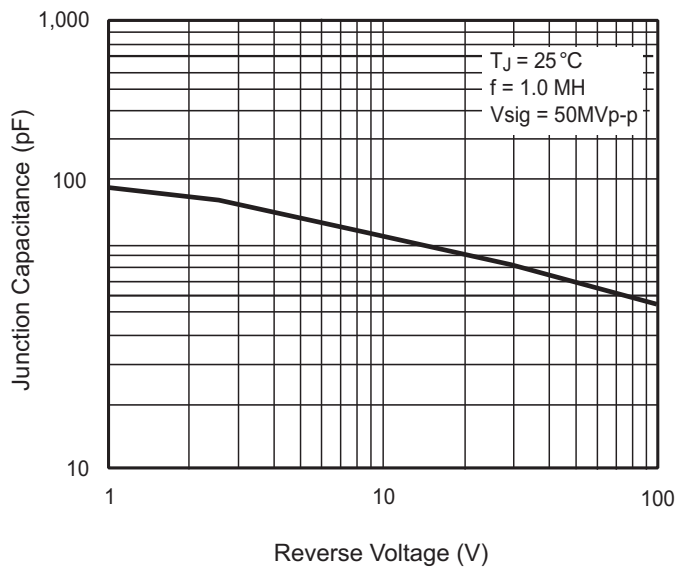


Fig.8 Typical Transient Thermal Impedance Per Leg

